



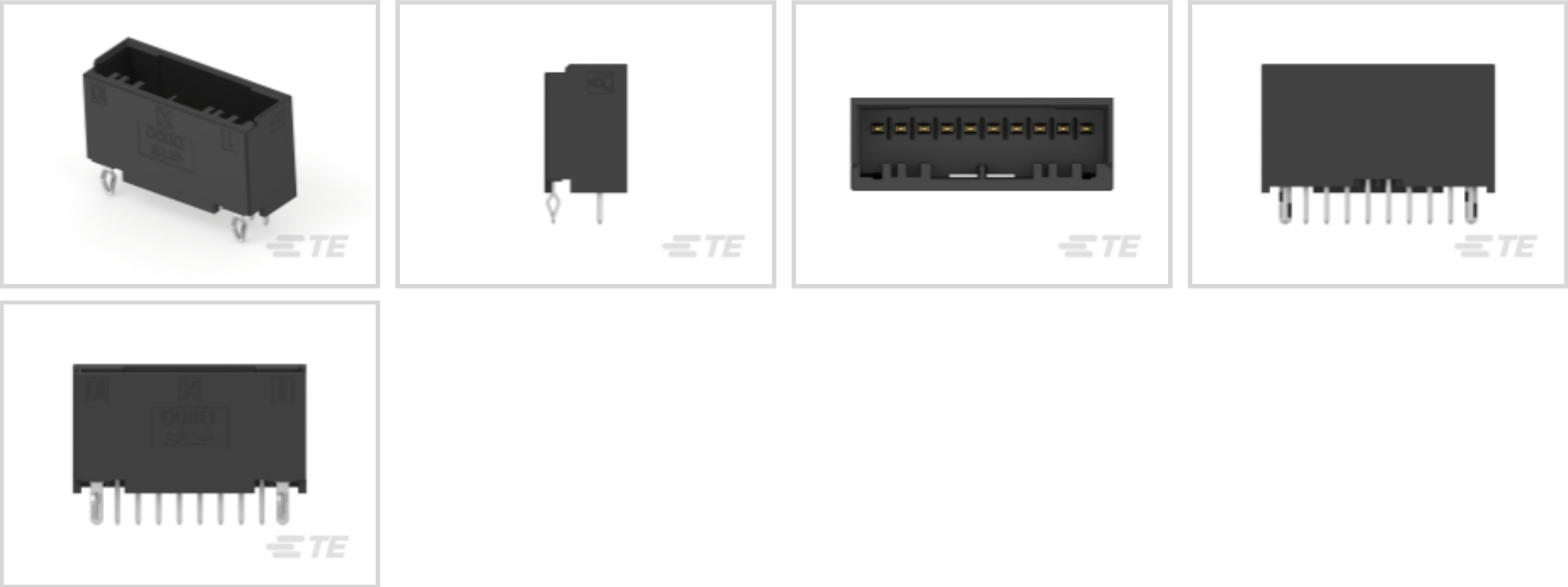
TE Internal #: 1-2394617-0

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2 mm [.079 in] Centerline, Header & Ejector Assembly, Gold, Through Hole

- Solder, Power

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Wire-to-Board**

Number of Positions: **10**

Number of Rows: **1**

Features

Electrical Characteristics

Operating Voltage	125 VDC
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Dimensions

Connector Width	8 mm[.315 in]
PCB Thickness (Recommended)	1 – 1.6 mm[.039 – .063 in]
Connector Height	12.45 mm[.49 in]
Connector Length	22.6 mm[.89 in]

Packaging Features

Packaging Quantity	21
Packaging Method	Tube

Industry Standards

UL Rating	Certified
Compatible With Approved Standards Products	UL E28476
UL Flammability Rating	UL 94V-0

Usage Conditions



Operating Temperature (Max)	105 °C[221 °F]
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

Body Features

Connector & Keying Code	X
PCB Retention Feature Material	Copper Alloy
PCB Retention Feature Plating Material	Pre-Tin
Primary Product Color	Black

Operation/Application

Shielded	No
Circuit Application	Power

Mechanical Attachment

Panel Mount Feature	Without
Mating Retention	Without
Mating Alignment Type	Keyed
PCB Mount Retention Type	Retention Leg
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	With

Termination Features

Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Rectangular Termination Post & Tail Thickness	.46 mm[.018 in]
Termination Post & Tail Length	3.05 mm[.12 in]
Termination Method to PCB	Through Hole - Solder

Contact Features

Contact Underplating Material	Nickel
Contact Underplating Material Thickness	1.27 µm[50 µin]
Contact Mating Area Plating Material Thickness	.38 µm[15 µin]
Mating Tab Width	.7 mm[.028 in]
PCB Contact Termination Area Plating Material Thickness	1 µm[39.37 µin]
Contact Shape & Form	Rectangular
Contact Layout	Inline



Contact Mating Area Length	3.6 mm[.142 in]
Contact Base Material	Copper Alloy
Mating Tab Thickness	.5 mm[.02 in]
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold
Contact Type	Tab
Contact Current Rating (Max)	3.5 A

Housing Features

Mating Entry Location	Top
Housing Material	Glass-Filled Thermoplastic Polyester
Centerline (Pitch)	2 mm[.079 in]

Configuration Features

Number of Columns	10
Number of Loaded Positions	10
Number of Power Positions	10
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	10
Number of Rows	1

Product Type Features

Mixed & Hybrid Header	No
Connector Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Header & Ejector Assembly
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Documents

Product Drawings
[D1100S HDR ASSY, 10POS, V-TYPE, AU-PL](#)
English

CAD Files
[3D PDF](#)
3D
Customer View Model
[ENG_CVM_CVM_1-2394617-0_1.2d_dxf.zip](#)

1-2394617-0

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2 mm [.079 in] Centerline, Header & Ejector Assembly, Gold, Through Hole - Solder, Power



English

Customer View Model

[ENG_CVM_CVM_1-2394617-0_1.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1-2394617-0_1.3d_stp.zip](#)

English

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